

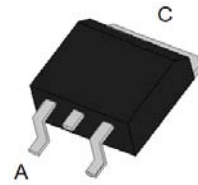


SM6D Series

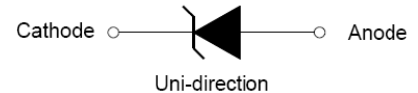
Rev.1.0

DESCRIPTION:

SM6D series TVS diodes have been designed to protect automotive sensitive circuits against surges defined in ISO 7637-2 and ISO 16750 tests A and B also called load-dump.



TO-263



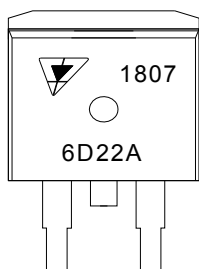
FEATURES:

- Stand-off voltage range: from 18 to 70V.
- Low leakage current: 1μA at 25 °C.
- Operating $T_{J(max)}$: 175 °C.
- High power capability at $T_{J(max)}$
- RoHS and halogen free.
- Resin meets UL 94V -0.
- AEC-Q101 compliant
- ISO 7637-2
 - Pulse 1: $V_S = -150$ V
 - Pulse 2a: $V_S = +112$ V
 - Pulse 3a: $V_S = -220$ V
 - Pulse 3b: $V_S = +150$ V
 - Formerly pulses 5a and 5b

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$, RH=45%-75%, unless otherwise noted)

	Parameter	Symbol	Value	Unit
Peak pulse voltage	ISO 10605 (C=330pF, R=330Ω)	V_{PP}	30	kV
	-contact discharge		30	
	-air discharge		30	
	IEC 61000-4-2		30	
	-contact discharge		30	
	-air discharge		30	
Peak pulse power dissipation on 10/1000μs waveform		P_{PP}	5000	W
Operating junction and storage temperature range		T_J, T_{STG}	-55 to +175	°C
Typical thermal resistance, junction to case		$R_{\theta JC}$	0.75	°C/W

MARKING



6D22A:Device Marking Code
1807:In seventh week,2018

ELECTRICAL CHARACTERISTICS

Part Number	Marking	Breakdown voltage $V_{BR} @ I_T(V)$		Test current $I_T (mA)$	Standoff voltage $V_R (V)$	$I_R @ V_R(\mu A)$		$V_C @ I_{PP} (V)$	$I_{PP} \text{①} (A)$
		Min	Max			25°C	175°C		
SM6D18A	6D18A	20.0	22.1	5	18	1	100	29.2	172.0
SM6D20A	6D20A	22.2	24.5	5	20	1	100	32.4	155.0
SM6D22A	6D22A	24.4	27.0	5	22	1	100	36.0	140
SM6D24A	6D24A	26.7	29.5	5	24	1	100	40.0	120
SM6D26A	6D26A	28.9	31.9	5	26	1	100	40.0	125
SM6D28A	6D28A	31.1	34.4	5	28	1	100	43.5	110
SM6D30A	6D30A	33.3	36.8	5	30	1	100	45.5	95
SM6D33A	6D33A	36.7	40.6	5	33	1	100	51.5	85
SM6D36A	6D36A	40.0	44.2	5	36	1	100	57	77
SM6D40A	6D40A	44.4	49.1	5	40	1	100	63	65
SM6D43A	6D43A	47.8	52.8	5	43	1	100	68	55
SM6D48A	6D48A	53.3	58.9	5	48	1	100	76	48
SM6D58A	6D58A	64.4	71.2	5	58	1	100	92	42
SM6D70A	6D70A	77.8	86.0	5	70	1	100	113	35

Note: Typical $V_F=1.9V$ at $I_F=100A$ measured on a $300\mu s$ square pulse width.

① Surge waveform: 10/1000 μs

V_R : Stand-off voltage -- Maximum voltage that can be applied

V_{BR} : Breakdown voltage

V_C : Clamping voltage -- Peak voltage measured across the suppressor at a specified I_{PP}

I_T : Test current

MECHANICAL DATA

Case: TO-263 molding compound meets UL 94V-0 flammability rating base

P/NHE3-RoHS-compliant, AEC-Q101 qualified.

Terminals: Matte tin plated leads, solder able per J-STD-002 and JESD 22-B102,

HE3 suffix meets JESD 201 class 2 whisker tests.

RATINGS AND CHARACTERISTICS CURVES ($T_A=25^{\circ}C$, unless otherwise noted)

FIG.1:V- I curve characteristics (Uni-directional)

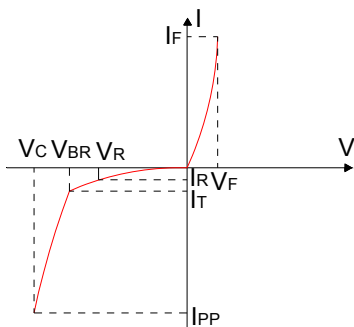


FIG.2: Pulse waveform

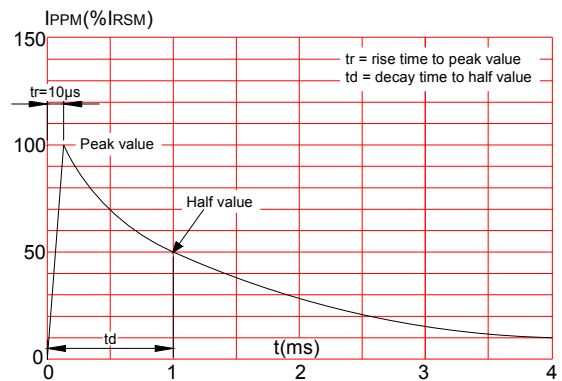


FIG.3: Load dump power characteristics (1ms exponential waveform)

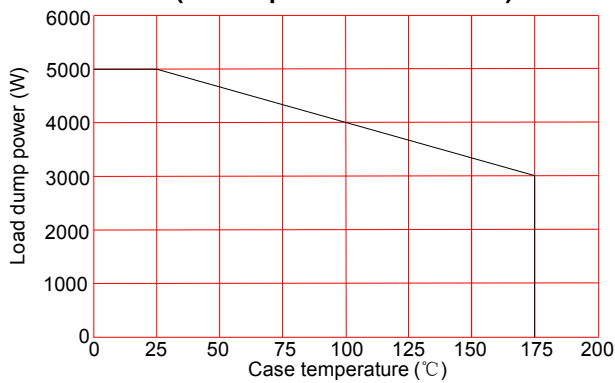


FIG.4: Peak pulse power vs. exponential pulse duration

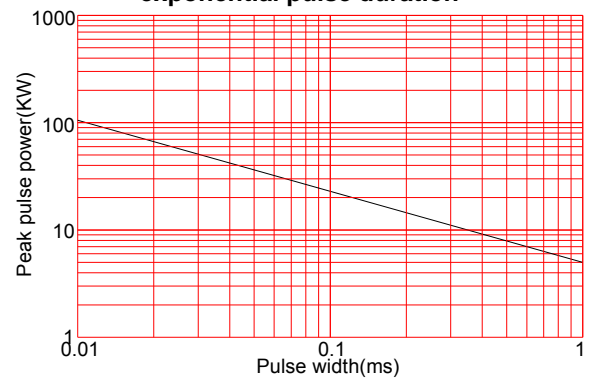


FIG.5: ISO7637-2,pulse 5a definition

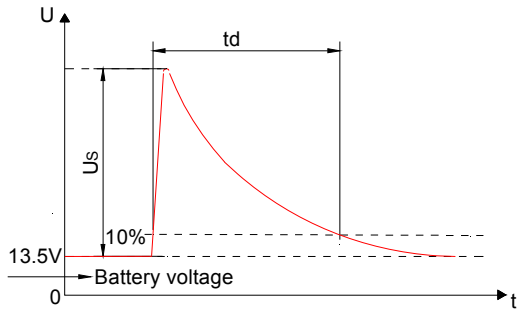


FIG.7: ISO7637-2,pulse 5b definition

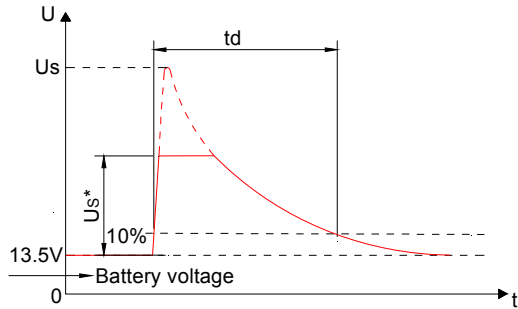


FIG.9: Peak forward voltage vs. peak forward current(typical value)

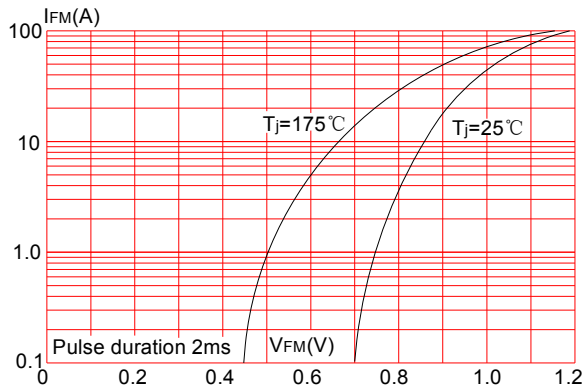


FIG.6: Load dump capability (Us=f(Ri) pulse 5a)

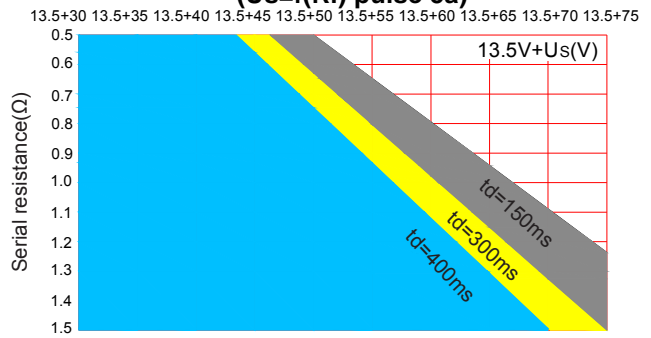


FIG.8: Load dump capability (Us*=f(Ri) pulse 5b,Us=87V)

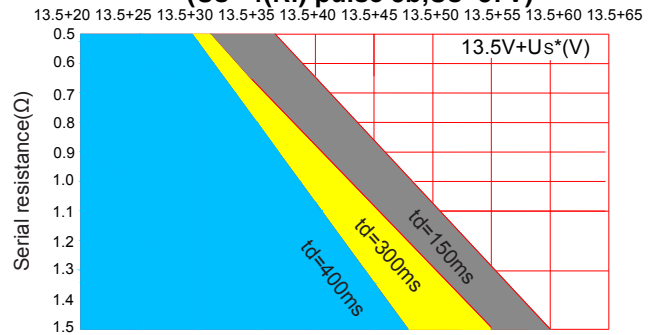
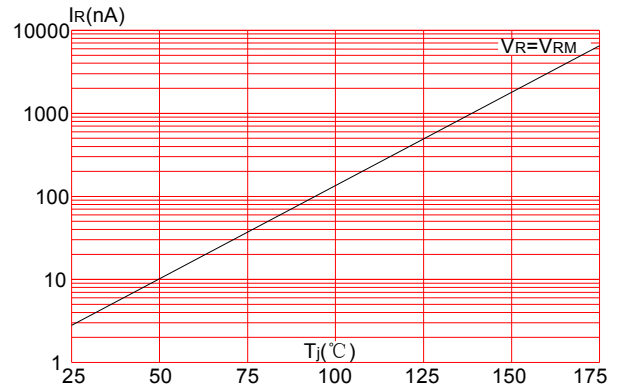
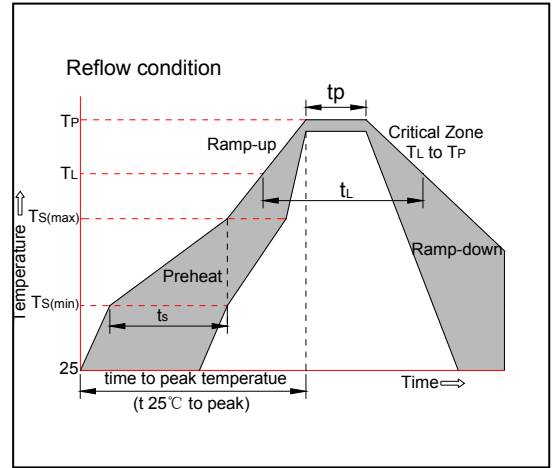


FIG.10: Leakage current vs. junction temperature(typical value)

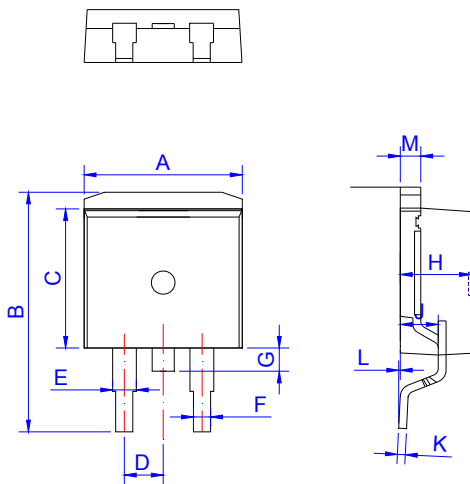


SOLDERING PARAMETERS

Reflow Condition		Pb-Free assembly (see figure at right)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150°C
	-Temperature Max($T_{s(max)}$)	+200°C
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquidus Temp (T_L) to peak)		3°C/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature(T_L)(Liquidus)	+217°C
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_p)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		20-40 secs.
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp (T_p)		8 min. Max
Do not exceed		+260°C



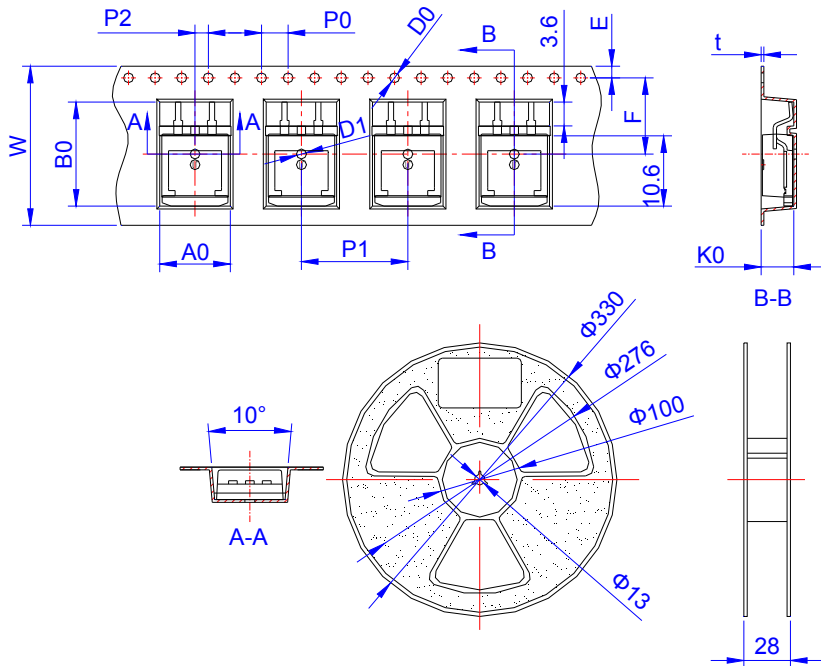
PACKAGE MECHANICAL DATA



TO-263

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	9.90		10.20	0.390		0.402
B	14.70		15.80	0.579		0.622
C	9.4		9.6	0.37		0.378
D		2.54			0.100	
E	1.20		1.40	0.047		0.055
F	0.75		0.85	0.029		0.033
G			1.75			0.069
H	4.40		4.70	0.173		0.185
J	2.30		2.70	0.091		0.106
K	0.38		0.55	0.015		0.022
L	0	0.10	0.25	0	0.004	0.010
M	1.25		1.35	0.049		0.053

TAPE AND REEL SPECIFICATION-TO-263



Ref.	Dimensions	
	Millimeters	Inches
W	24.00±0.30	0.945±0.012
E	1.75±0.10	0.069±0.004
F	11.50±0.10	0.453±0.004
D0	1.50±0.10	0.059±0.004
D1	1.50±0.10	0.059±0.004
P0	4.00±0.10	0.157±0.004
P1	16.00±0.10	0.630±0.004
P2	2.00±0.10	0.079±0.004
A0	10.90±0.10	0.429±0.004
B0	16.30±0.10	0.642±0.004
K0	4.90±0.10	0.193±0.004
t	0.40±0.05	0.016±0.002


OUTLINE	UNIT WEIGHT (g/PCS) typ.	REEL (PCS)	PER CARTON (PCS)	REEL DIAMETERS (mm)
TAPING	1.598	800	4,000	330

Information furnished in this document is believed to be accurate and reliable. However, Jiangsu JieJie Microelectronics Co.,Ltd assumes no responsibility for the consequences of use without consideration for such information nor use beyond it.

Information mentioned in this document is subject to change without notice, apart from that when an agreement is signed, Jiangsu JieJie complies with the agreement.

Products and information provided in this document have no infringement of patents. Jiangsu JieJie assumes no responsibility for any infringement of other rights of third parties which may result from the use of such products and information.

This document is the first version which is made in 23-Feb.-2018. This document supersedes and replaces all information previously supplied.

 is a registered trademark of Jiangsu JieJie Microelectronics Co.,Ltd.

Copyright ©2018Jiangsu JieJie Microelectronics Co.,Ltd. Printed All rights reserved.